

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
QIU LAN CHEN	06/19/2014
HO PUI HO	06/20/2014
SIU KAI KONG	06/13/2014
YIU WA KWAN	06/13/2014
HO CHIN KWOK	06/13/2014
YICK KEUNG SUEN	06/11/2014
SHU YUEN WU	06/13/2014
KAR LAI ALICE YANG	06/11/2014
JUN QIANG ZHOU	05/21/2014
RECEIVING PARTY DATA	
Name:	THE CHINESE UNIVERSITY OF HONG KONG
Street Address:	SHATIN, NEW TERRITORIES
City:	HONG KONG
State/Country:	CHINA
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14344827
CORRESPONDENCE DATA	
Fax Number:	(949)760-9502
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	9497600404
Email:	efiling@knobbe.com
Correspondent Name:	KNOBBE MARTENS OLSON & BEAR LLP
Address Line 1:	2040 MAIN STREET
Address Line 2:	14TH FLOOR
Address Line 4:	IRVINE, CALIFORNIA 92614
ATTORNEY DOCKET NUMBER:	INSIG16.001APC
NAME OF SUBMITTER:	NEIL S. BARTFELD
SIGNATURE:	/Neil S. Bartfeld/

PATENT

DATE SIGNED:	07/03/2019
Total Attachments: 3 source=INSIG16-001APC_Assignment_ChineseUniv#page1.tif source=INSIG16-001APC_Assignment_ChineseUniv#page2.tif source=INSIG16-001APC_Assignment_ChineseUniv#page3.tif	

ASSIGNMENT

WHEREAS, WE, **CHEN Qiu Lan, HO Ho Pui, KONG Siu Kai, KWAN Yiu Wa, KWOK Ho Chin, SUEN Yick Keung, WU Shu Yuen, YANG Kar Lai Alice and ZHOU Jun Qiang**, ASSIGNORS, citizens of China, Great Britain, Great Britain, Hong Kong, Hong Kong, Hong Kong, Hong Kong, Hong Kong and China, residing at Room 701, Block Qu Yuan A, Yangcheng Garden, 2 Dyue Street, Middle Zhongshan Avenue, Tianhe District, Guangzhou 510000, China, Flat 1C, Comfort Court, 1 Marconi Road, Kowloon, Hong Kong, Flat A, 2nd Floor, Tower 12A, Laguna Verde, Hung Hom, Kowloon, Hong Kong, Flat B, 7th Floor, Block 1, Pristine Villa, 18 Pak Lok Path, To Fund Shan Toad, Shatin, Tai Wai, New Territories, Hong Kong, Flat D, 12th Floor, Tower 8, Island Harbourview, Hoi Fai Road, Kowloon, Hong Kong, Flat 3, 32nd Floor, Ka Yeung House, Ka Shing Court, Fanling, New Territories, Hong Kong, Room 2032, 23rd Floor, Wah Sang House, Wah Fu Estate, Hong Kong, Room 2517, 25th Floor, Tai On Building, 57-87 Shau Kei Wan Road, Sai Wan Ho, Hong Kong and BLK268, Toh Guan Road, #11-45, Singapore 600268, respectively, are the inventors of the invention in

Microfluidic Platform and Method for Controlling the Same

for which we have executed an application for a Patent of the United States

which is identified by Knobbe Martens Olson & Bear LLP docket no. INSIG16.001APC which was filed on **13 March 2014**, Application No. **14/344,827** based on the PCT Application No. **PCT/CN2012/081197** filed on **10 September 2012**.

and WHEREAS, The Chinese University of Hong Kong, ASSIGNEE, located at Shatin, New Territories, Hong Kong, is desirous of obtaining our entire right, title and interest in, to and under the said invention and the said application:

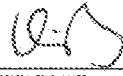
NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to us in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, WE, the said ASSIGNORS, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, our entire right, title and interest in, to and under the said invention, and the said United States application and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said invention in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said United States application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable, and all forms of industrial property protection, including without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewal and reissues thereof;

AND WE HEREBY authorize and request the Commissioner of Patents, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant and agree that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

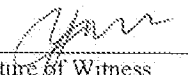
AND WE HEREBY further covenant and agree that we will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testifying in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths, and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries.

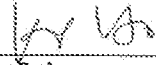
IN TESTIMONY WHEREOF, We hereunto set our hands and seals the day and year set opposite our respective signatures.

Date 19 June 2014, 2014

 _____ L.S.
CHEN Qiu Lan

Witness:

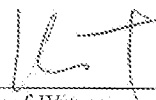
CHAN HO YAN
 Printed Name of Witness

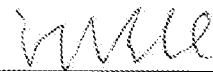


 Signature of Witness
Date 20 June 2014, 2014

 _____ L.S.
HO Ho Pui

Witness:

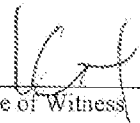
CHEUNG YING KIT
 Printed Name of Witness

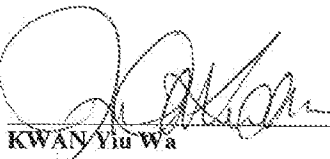


 Signature of Witness
Date 13 June, 2014

 _____ L.S.
KONG Siu Kai

Witness:


CHEUNG YING KIT
 Printed Name of Witness




 Signature of Witness
Date 13 June, 2014

 _____ L.S.
KWAN Yiu Wa

Witness:


CHEUNG YING KIT
 Printed Name of Witness



 Signature of Witness
Date 13 June, 2014

 _____ L.S.
KWOK Ho Chin

Witness:

CHEUNG YING KIT
 Printed Name of Witness



 Signature of Witness

Date 11 June 2014, 2014

Suen L.S.
SUEN Yick Keung

Witness:

CHEUNG YING KIT
 Printed Name of Witness

[Signature]
 Signature of Witness

Date 13 June, 2014

Wu Shu Yuen L.S.
WU Shu Yuen

Witness:

CHEUNG YING KIT
 Printed Name of Witness

[Signature]
 Signature of Witness

Date 11 June, 2014

Alice Yang L.S.
YANG Kar Lai Alice

Witness:

CHEUNG YING KIT
 Printed Name of Witness

[Signature]
 Signature of Witness

Date 21 May, 2014

[Signature] L.S.
ZHOU Jun Qiang

Witness:

CHEUNG YING KIT
 Printed Name of Witness

[Signature]
 Signature of Witness